

Dalian Good Display Co.,Ltd.

LCD Module User Manual

YM16064FSF-1

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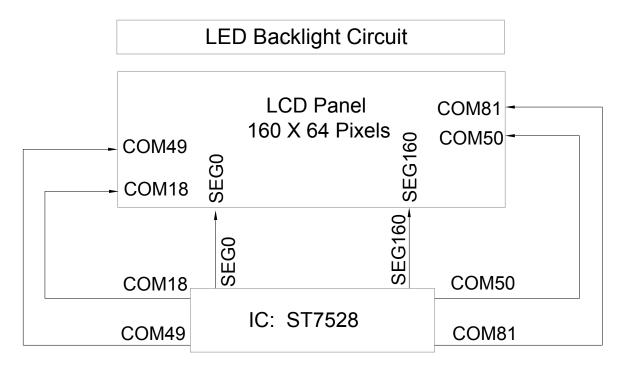


1.0 Basic Specification

1.1 Display and Mechanical Specification

ITEM	STANDARD VALUE	UNIT
Display Type	160 X 64	Dots
LCD Type	FSTN/ Transflective/Positive	
LCD Duty	1/64	
LCD Bias	1/9	Bias
Viewing Direction	6:00	Clock
Backlight Type	White Color LED Backlight with frame	
Interface	6800/8080 series or Serial Interface	
Driver IC	ST7528 (Gold Bump Chip)	
IC Package	COG	
Module Dimension	56.4(W)×32.9(H) ×5.20(T) (MAX)	mm
Visual Area	52.00(W) ×22.00(H)	mm
Dot size	0.28 ×0.28	mm
Dot Pitch	0.30 ×0.30	mm
Operating Temperature	-20 ~ 70	$^{\circ}$
Storage Temperature	-30 ~ 80	$^{\circ}$

1.2 Block Diagram





1.3 Terminal Functions

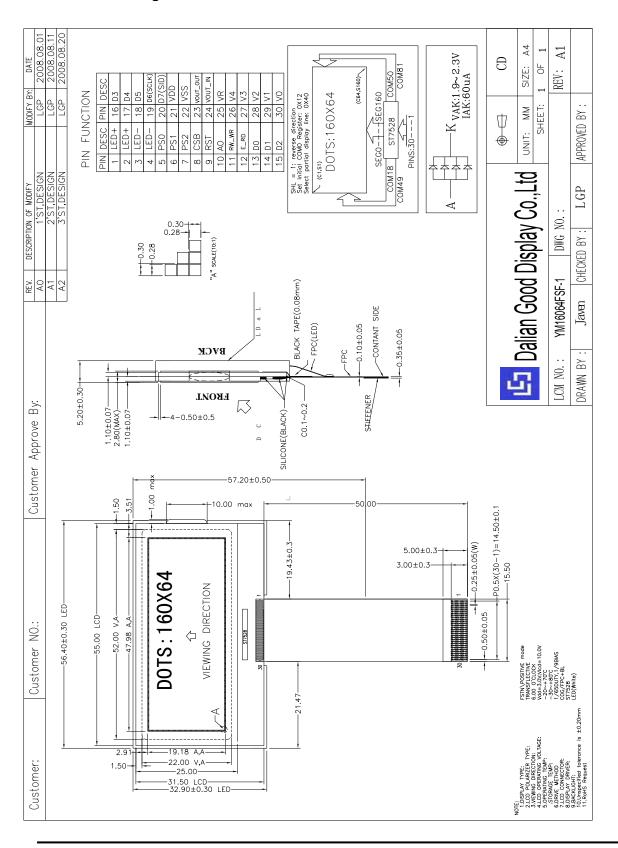
Pin	Pin	1/0	D	Descriptions							
No.	Name	I/O	Descri	ptions							
1	LED+	Supply	Positiv	Positive Supply for LED backlight							
2	LED+	Supply	Positiv	Positive Supply for LED backlight							
3	LED-	Supply	Negativ	ve Sup	ply for I	LED backlight					
4	LED-	Supply	Negativ	ve Sup	ply for I	LED backlight					
5	PS0		Paralle	l/Serial	l data ir	nput select inpu	t				
6	PS1		PS2	PS1	PS0	Interface	Data/	Data	Read/Write	Serial Clock	
						mode	Command				
			L	L	Н	Parallel 80	A0	DB0 to DB7	RD/WR	-	
		I	L	Н	Н	Parallel 68	A0	DB0 to DB7	E/RW	-	
7	PS2		L	L	L	3Line Serial	-	S1D(DB7)	Write only	SCLK(DB6)	
			L	Н	L	4Line Serial	A0	S1D(DB7)	Write only	SCLK(DB6)	
			Н	L	L	IIC Serial	-	SDA	Read/Write	SCL	
			Note: I	n 4-Lin	e, 3-Lir	e and IIC seria	I mode, it is imp	ossible to read	data from the o	n-chip RAM.	
	CSB		Chip S	elect in	put pin	S					
8		1	I Data/instruction I/O is enabled only when CSB is "L". When chip select is non-ac							elect is non-act	ive , DB0 to DB7
			may be	high i	mpedaı	nce.	*				
9	RST	ı	Reset i	input pi	in						
9	KOT	ı	When I	RESET	B is "L'	", initialization is	s executed.				
			Registe	er seled	ct input	pin					
10	A0	1	-A0 = "	H" : DE	30 to DI	37 are display o	data.				
			-A0 = "	L" : DB	0 to DE	37 are control d	ata.				
			Read/	Write e	xecutio	n control pin					
			PS1		MPU 1	type	RW_WR	Description	l		
			Н	H 6800-series			RW	Read/Write	Read/Write control input pin		
								RW = "H":	read		
11	RW_WR	I						RW= "L":	write		
			L 8080-series /WR Write enable clock input pin						n		
								The data o	DB0 to DB7 are	e latched at the	
								rising edge	of the /WR sigr	nal.	



			Read/ Write	Read/ Write execution control pin							
			PS1	MPU type	E_RD	Description					
			Н	6800-series	E	Read/Write control input pin					
						When RW = "H" E is "H", DB0 to					
						B7 are in an output status.					
12	E RD	ı				When RW="L": The data on DB0					
	'					to DB7 are latched at the falling					
						edge of the E signal.					
			L	8080-series	/RD	Read enable clock input pin					
						When /RD is "L", DB0 to DB7 are in an					
						output Status.					
			This is an 9	hit hi directional dat	a hus that conn	ects to an 8-bit or 16-bit standard MPU data bus.					
		30-DB7 I/O									
13-20	DB0-DB7		When the serial interface is selected (P/S="L"), then DB7 serves as the serial data input terminal (SI) and DB6 serves as the serial clock input terminal (SCL). At this time, DBO-DB5 are set to high								
			impedance. When the chip select is inactive, DB0-DB7 are set to high impedance.								
21	VDD	Supply	· ·	Positive Power Supply							
22	VSS	Supply	Ground								
	700	- Сарріј	If the interna	Il Vout voltage gener	ator is used the	VOLIT IN & VOLIT OLIT must be connected					
23	VOUT_O	Supply		If the internal Vout voltage generator is used , the VOUT_IN & VOUT_OUT must be connected together. If an external supply is used , this pin must be left open.							
						using the VOUT IN pad. In this case, VOUT OUT					
24	VOUT_IN	Supply			2 €	erator has to be programmed to zero.					
				idjustment pin							
25	VR	I			tors are not used	d (INTRS = "L")					
			It is valid only when on-chip resistors are not used (INTRS = "L") When using internal resistors (INTRS = "H"), open this pin								
26	V4		LCD driver s	supply voltages. The	voltage determin	ned by LCD cell					
27	V3		is impedance	is impedance-converted by a resistive driver or and according to the following relationship:							
28	V2	I/O	VDD (=Vo)≥	≥ V1≥V2≥V3≥V4≥VS	3						
29	V1		When the or	When the on-chip operating power circuit is on the following voltages are supplied to V1 to V4 by							
30	V0		the on-chip	oower circuit.							



1.4 Mechanical Drawing





2. Absolute Maximum Ratings

Items	Symbol	Min	Max.	Unit	Condition
Supply Voltage (Logic)	V _{DD} -Vss	-0.5	+3.6	V	V _{ss} =0V
Supply Voltage (LCD Driver)	Vout_in	-0.5	20	V	V _{ss} =0V
Input Voltage	Vin	-0.5	VDD+0.5	V	V _{ss} =0V
Operating Temperature	Тор	-20	+70	$^{\circ}$	No Condensation
Storage Temperature	Тѕт	-30	+80	$^{\circ}$	No Condensation

Cautions:

Any stresses exceeding the Absolute Maximum Ratings may cause substantial damage to the device Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability

3. Electrical Characteristics

3.1 DC Characteristics

Items	Symbol	Min	Тур.	Max.	Unit	Condition
Supply Voltage (Logic)	V _{DD} -Vss	2.7	3.0	3.3	V	
Supply Voltage (LCD Driver)	Vo		10.0		V	25℃
Input Voltage	ViH	0.7 Vdd		V _{DD}	V	
	VIL	Vss		0.3 V _{DD}	v	
Logic Supply Current	IDD			0.7	mA	VDD-Vss=3.0V

3.2 LED Backlight Circuit Characteristics

Items	Symbol	MIN	TYP.	MAX.	Unit	Application pin
Forward Voltage	VfLED+	-	2.1	-	V	LED+
Forward Current	IfLED+	-	60	80	mA	LED+

Cautions:

Exceeding the recommended driving current could cause substantial damage to the backlight and shorten its lifetime.



4. IC Contents Attachment:

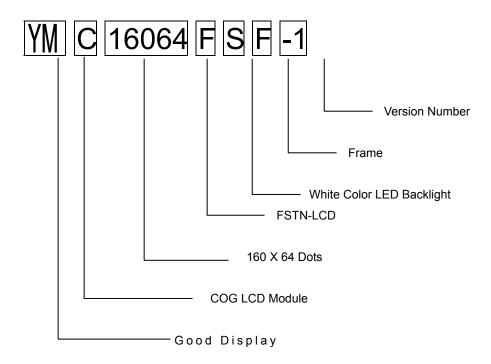
Reference Documents from SITRONIX ST7528_2.3V LCD Driver.

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5. LCM Numbering System





6. Design and Handling Precaution

- 1.0 The LCD panel is made by glass. Any mechanical shock (eg. dropping form high place) will damage the LCD module.
- 2.0 Do not add excessive force on the surface of the display, which may cause the Display color change abnormally.
- 3.0 The polarizer on the LCD is easily get scratched. If possible, do not remove the LCD protective film until the last step of installation.
- 4.0 Never attempt to disassemble or rework the LCD module.
- 5.0 Only Clean the LCD with Isopropyl Alcohol or Ethyl Alcohol. Other solvents (eg. water) may damage the LCD.
- 6.0 When mounting the LCD module, make sure that it is free form twisting, warping and distortion.
- 7.0 Ensure to provide enough space (with cushion) between case and LCD panel to prevent external force adding on it, or it may cause damage to the LCD or degrade the display result.
- 8.0 Only hold the LCD module by its side. Never hold LCD module by adds force on the heat seal or TAB.
- 9.0 Never add force to component of the LCD module. It may cause invisible damage or degrade of the reliability.
- 10.0 LCD module could be easily damaged by static electricity. Be careful to maintain an optimum anti-static work environment to protect the LCD module.
- 11.0 When peeling off the protective film from LCD, static charge may cause abnormal display pattern. It is normal and will resume to normal in a short while.
- 12.0 Take care and prevent get hurt by the LCD panel sharp edge.
- 13.0 Never operate the LCD module exceed the absolute maximum ratings.
- 14.0 Keep the signal line as short as possible to prevent noisy signal applying to LCD module.
- 15.0 Never apply signal to the LCD module without power supply.
- 16.0 IC chip (eg. TAB or COG) is sensitive to the light. Strong lighting environment could Possibly cause malfunction. Light sealing structure casing is recommend.
- 17.0 LCD module reliability may be reduced by temperature shock.
- 18.0 When storing the LCD module, avoid exposure to the direct sunlight, high humidity, high temperature or low temperature. They may damage or degrade the LCD module

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